



### 30V P-Channel Enhancement Mode MOSFET

Voltage

-30 V

Current

-45 A

#### **Features**

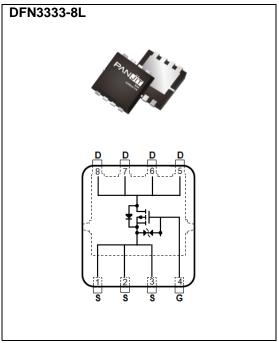
- RDS(ON), VGS@-10V, ID@-10A<12.5m $\Omega$
- RDS(ON), VGS@-4.5V, ID@-6A<20.3m $\Omega$
- 100% UIS tested
- Reliable and Rugged
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

• Case: DFN3333-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.03 grams



### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	-30	V	
Gate-Source Voltage		V <sub>GS</sub>	±25	\ \	
Continuous Drain Current(Note 3)	T <sub>C</sub> =25°C	l <sub>D</sub>	-45		
	T <sub>C</sub> =100°C		-32	А	
Pulsed Drain Current(Note 1)	T <sub>C</sub> =25°C	I <sub>DM</sub>	-138		
Power Dissipation	T <sub>C</sub> =25°C	Po	41	W	
	T <sub>C</sub> =100°C		20		
Continuous Drain Current(Note 4)	T <sub>A</sub> =25°C	I <sub>D</sub>	-11.2		
	T <sub>A</sub> =70°C		-9.4	A	
Power Dissipation	T <sub>A</sub> =25°C	D-	2.5	W	
	T <sub>A</sub> =70°C	Po -	1.8		
Single Pulse Avalanche Energy <sup>(Note 5)</sup>		Eas	56	mJ	
Operating Junction and Storage Temperature Range		$T_{J}, T_{STG}$	-55~175	°C	
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	$R_{ heta JC}$	3.7	°C/W	
	Junction to Ambient	$R_{\theta JA}$	60		





### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static			_				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA -30		-	-		
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	-1	-1.8	-2.5	V	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-10A	-	10	12.5	mΩ	
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-6A	-	15.6	20.3		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V	-	-	-1	uA	
<u>-</u>	I <sub>GSS</sub>	V <sub>GS</sub> =±25V, V <sub>DS</sub> =0V	-	-	±10	uA	
Gate-Source Leakage Current		V <sub>GS</sub> =±10V, V <sub>DS</sub> =0V	-	-	±1		
Dynamic <sup>(Note 6)</sup>			_	_		_	
Total Gate Charge	$Q_g$	\/ O4\/   40A	-	34	-	nC	
Gate-Source Charge	Qgs	V <sub>DS</sub> =-24V, I <sub>D</sub> =-10A,	-	5	-		
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =-10V	-	9	-		
Input Capacitance	Ciss	V 05V V 0V	-	1610	-		
Output Capacitance	Coss	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V,	-	275	-	pF	
Reverse Transfer Capacitance	Crss	f=1MHz	-	210	-		
Gate resistance	Rg	f=1MHz	-	8	-	Ω	
Turn-On Delay Time	td <sub>(on)</sub>	N 04N/ L 40A	-	7	-		
Turn-On Rise Time	tr	V <sub>DS</sub> =-24V, I <sub>D</sub> =-10A,	-	4	-	ns	
Turn-Off Delay Time	td <sub>(off)</sub>	V <sub>GS</sub> =-10V, R <sub>G</sub> =3 $\Omega$	-	51	-		
Turn-Off Fall Time	tf	(14010-2)	-	66	-		
Drain-Source Diode			_				
Diode Forward Current	Is	Tc=25°C	-	-	-45	A	
Pulsed Diode Forward Voltage	I <sub>SM</sub>	1C=25 C	-	-	-138		
Diode Forward Voltage	V <sub>SD</sub>	Is=-20A, V <sub>G</sub> S=0V	-	-0.85	-1.3	V	
Reverse Recovery Time	Trr	V <sub>GS</sub> =0V, I <sub>S</sub> =-20A	-	16	-	ns	
Reverse Recovery Charge	Qrr	dl <sub>S</sub> /dt=100A/us	_	7	-	nC	

#### NOTES:

- 1. Pulse width<a></a>300us, Duty cycle<a></a>2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is package limited.
- 4. R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH,  $I_{AS}$ =-15A,  $V_{DD}$ =-30V,  $V_{GS}$ =-10V, Starting  $T_{J}$ =25°C.
- 6. Guaranteed by design, not subject to production testing.





#### **TYPICAL CHARACTERISTIC CURVES**

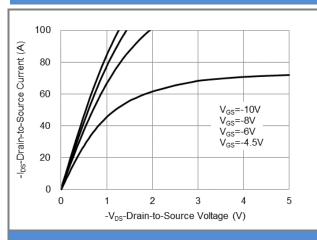
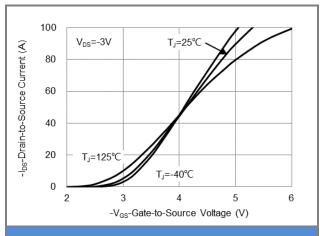


Fig.1 On-Region Characteristics



**Fig.2 Transfer Characteristics** 

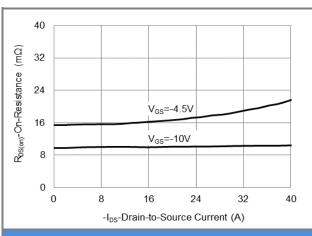


Fig.3 On-Resistance vs. Drain Current

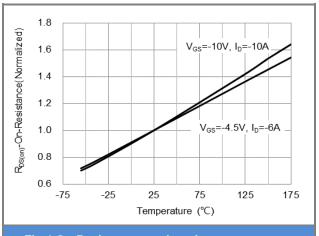


Fig.4 On-Resistance vs. Junction temperature

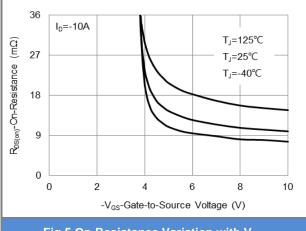
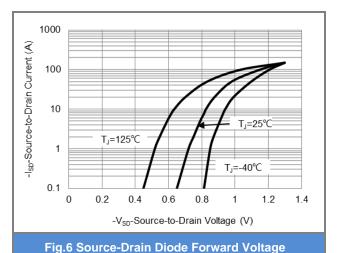


Fig.5 On-Resistance Variation with V<sub>GS</sub>







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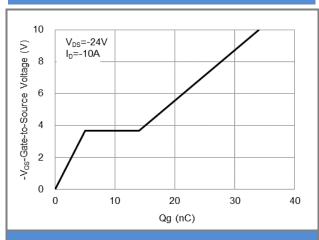


Fig.7 Gate-Charge Characteristics

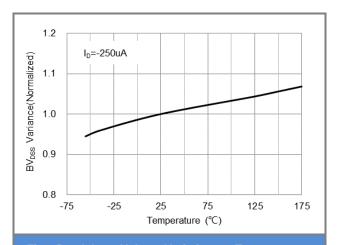


Fig.8 Breakdown Voltage Variation vs. Temperature

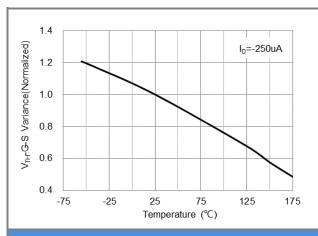


Fig.9 Threshold Voltage Variation with Temperature

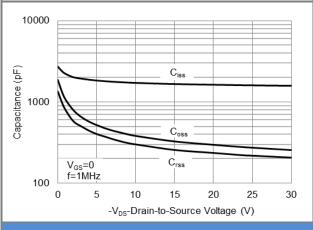
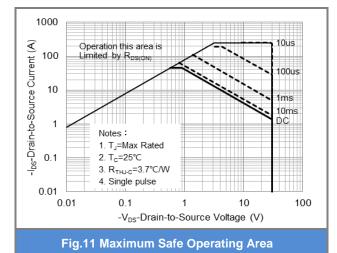


Fig.10 Capacitance vs. Drain-Source Voltage



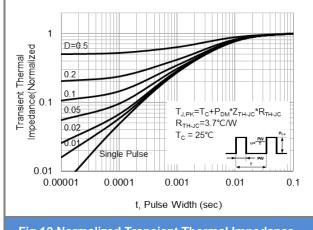


Fig.12 Normalized Transient Thermal Impedance

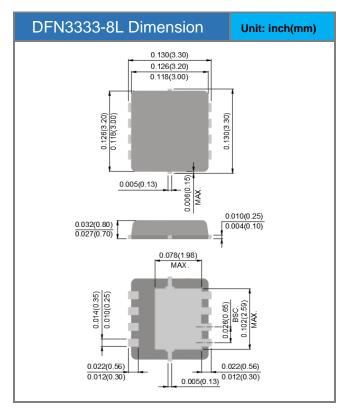


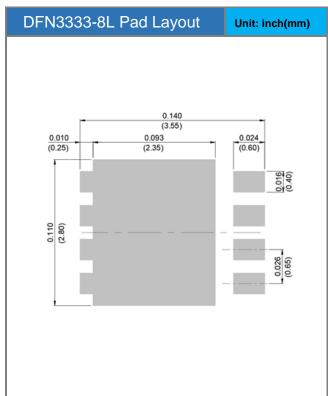


### **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking	
PJQ4435EP-AU	DFN3333-8L	5K pcs / 13" reel	435E	

### **Packaging Information & Mounting Pad Layout**









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